

Agilent ACPF-7001 High Rejection Tx Filter for US PCS Band

Data Sheet



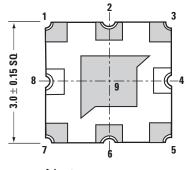
Description

This product is a high rejection full band transmit filter designed for US PCS handsets. Its performance rivals splitband surface acoustic wave (SAW) transmit filters. Since the rejection is provided by a single filter, no switches are required, saving board space and external components, eliminating switch loss, and reducing programming complexity.

In typical cellular phone architectures, the transmit filter fits between the driver amplifier and the power amplifier. This filter reduces the noise in the Rx band being amplified by the transmit chain, enhancing receiver sensitivity. High rejection keeps unwanted signals out of the receive path.

Agilent's thin-Film Bulk Acoustic Resonator (FBAR) technology makes possible high-Q filters at a fraction of their usual size.

Package



4: Input 8: Output 1, 2, 3, 5, 6, 7, 9: Grounded Center pad grounded See Figure 10 for details. "x" = date code character

Features

- High rejection from a single filter with no switches required
- Passband: 1850 1910 MHz
 33 dB min Attenuation, 1930 – 1990 MHz
 3.5 dB max Insertion Loss
- Space saving solution
 Small footprint: 3 x 3-mm solution
 Low profile package:

 1.1 mm high (typ)
 1.25 mm (max)

Applications

- US PCS band handsets
- Wireless data terminals



Electrical Specifications, Z_0 = 50Ω

				25°C		-30 $^{\circ}$ to +25 $^{\circ}$ C		25 $^{\circ}$ to +70 $^{\circ}$ C		70°C	
Symbol	Parameter	Units	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max
f	Passband	MHz	1850		1910	1850		1910	1850		1910
IL	Insertion Loss 1850-1855 MHz	dB		2.0	3.5			3.7			3.2
IL	Insertion Loss 1855-1905 MHz	dB		1.5	3.0			3.0			3.0
IL	Insertion Loss 1905-1910 MHz	dB		2.5	3.5			3.2			3.7
Δ S 21	Ripple, 1850-1910 MHz	dBm			2.5						
S21	Min Rejection, 1930-1990 MHz	dB	33	37		33			33		
S21	Min Rejection, 10-1800 MHz	dB			25						
S21	Min Rejection, 1990-3820 MHz	dBm			30						
S21	Min Rejection, 3820-5730 MHz	dBm		15							
S11, S22	In-band Return Loss	dB	9.0	11		9.0	11		9.0	11	
Pin max	Safe Input Power Level	dBm	20			20			20		

Absolute Maximum Ratings^[2]

Parameter	Unit	Value
Operating Temperature ^[1]	°C	-30 to +85
Storage Temperature ^[1]	۵°	-30 to +100

Notes:

- 1. Temperature is defined at case $T_{c'}$ the temperature of the underside of the filter where it makes contact with the circuit board.
- 2. Specifications are guaranteed over the given temperature range. Operation in excess of any one of these conditions may result in permanent damage to the device.

Typical Performance, 25° C, $Z_0 = 50\Omega$

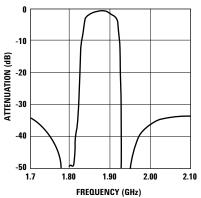
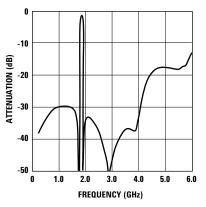


Figure 1. Attenuation vs. Frequency.





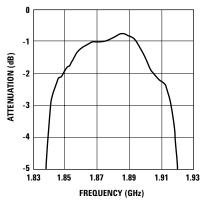


Figure 2. Insertion Loss vs. Frequency.

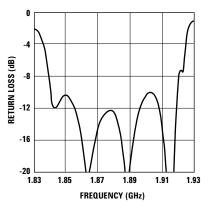


Figure 4. Return Loss vs. Frequency.

PCB Interface and Mounting Instructions

Mounting Consideration and Board Description

The ACPF-7001 filter has one input (Pin 4), one output (Pin 8) and 6 grounds (Pins 1, 2, 3, 5, 6, 7). Furthermore, the inside of the filter (center pad Pin 9) is ground-plane; therefore it must be soldered to PCB ground.

In summary:

- Pins 1, 2, 3, 5, 6, 7, 9 are grounded. (Figure 5)
- Demo board uses 14 mil Getek Microstrip. (see board layer Figure 6)

Note: For best performance, try to reproduce this board stack up closely. For example, if customer's ground layer is less than 14 mils, void the 1st ground layer (and others if necessary) and use the next available ground closest to 14 mils. If less than 14 mils dielectric is used, parasitic capacitance will slightly degrade the return loss and rejection. If Ground-Signal-Ground (GSG) type board is used, better return loss can be achieved since it eliminates connector mismatch.

Demo Boards

SMA connectorized Demo boards are available for sampling. (See board drawing in Figure 5).

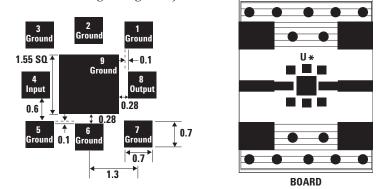
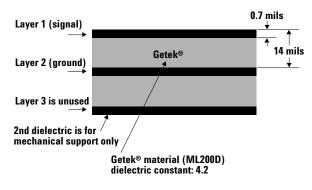
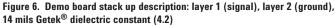
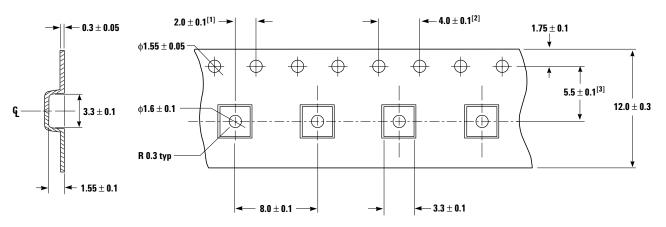


Figure 5. PCB footprint dimensions in mm; pad nomenclature and grounding description.







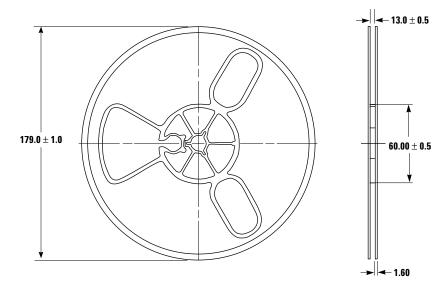
Notes:

1. Measured from centerline of sprocket hole to centerline of pocket

2. Cumulative tolerance of 10 sprocket holes is ± 0.20

All dimensions in millimeters unless otherwise stated.

Figure 7. Tape drawing.





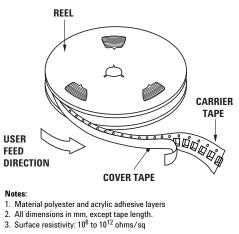


Figure 9a. Device orientation in the tape.

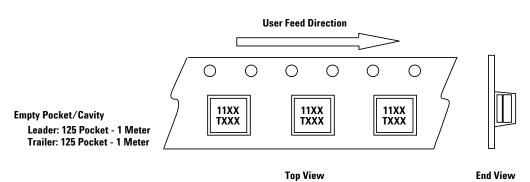


Figure 9b. Device orientation in the tape.

Ordering Information

Specify part number followed by option. For example: ACPF-7001- \underline{XXX}

— Bulk or Tape and Reel option

Option Descriptions

- -BLK = Bulk, 25 parts per antistatic bag
- -TR1 = Tape and Reel, 1000 devices per 7" reel

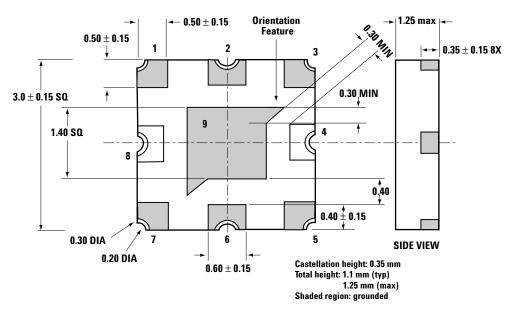


Figure 10. Detailed bottom and side view of package (dimensions in mm).

Alloy type	Melting temp. (°C)	Recommended working temperature (°C)	Comments			
Sn42Bi58	138	160 - 180	Lead free			
Sn43Pb43Bi14	144 – 163	165 – 185	Contains lead – some customers prohibit it			
Sn63Pb37	183	200 – 240	Contains lead – some customers prohibit it			
Sn60Pb40	186	200 - 240	Contains lead – some customers prohibit it			
Sn91/Zn9	199	200 - 240	May have oxidation problems			
Sn96.2Ag2.5Cu0.8Sb0.5	216	235 – 255	Popular lead free composition			
Sn95.8Ag3.5Cu0.7	217	235 – 255	Other alloy ratios are available			
Sn96.5Ag3.5	221	240 – 260	Used in the assembly of filters			
Sn100	232	260 - 280	Too hot – will melt package assembly			
Sn95Sb5	235	260 - 280	Too hot – will melt package assembly			
Sn97Cu3	240	260 - 300	Too hot – will melt package assembly			

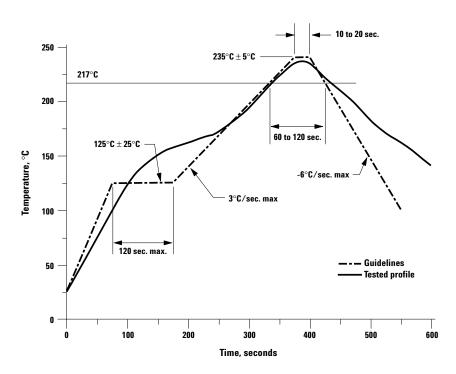


Figure 11. Recommended solder profile.

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